

August 2014

FCPF650N80Z — N-Channel SuperFET[®] II MOSFET

FCPF650N80Z

N-Channel SuperFET[®] II MOSFET

800 V, 8 A, 650 m Ω

Features

- R_{DS(on)} = 530 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 27 nC)
- Low E_{oss} (Typ. 2.8 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 124 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

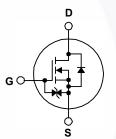
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





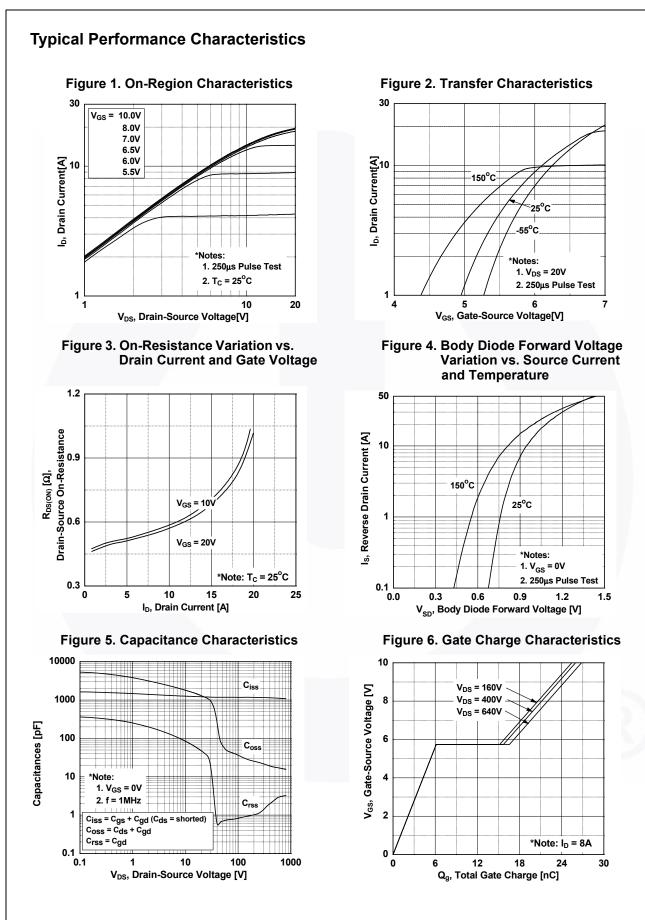
Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCPF650N80Z	Unit		
V _{DSS}	Drain to Source Voltage				
V _{GSS} Gate		- DC	- DC		V
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V
ID	Drain Current	- Continuous (T _C = 25 ^o C)	- Continuous (T _C = 25 ^o C)		А
		- Continuous (T _C = 100 ^o C)		5.1*	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	24*	Α
E _{AS}	Single Pulsed Avalanche Ene	204	mJ		
I _{AR}	Avalanche Current (Note 1)			1.6	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.305	mJ
dv/dt	MOSFET dv/dt	100	V/ns		
	Peak Diode Recovery dv/dt	20			
P _D	Rower Dissipation	(T _C = 25 ^o C)		30.5	W
	Power Dissipation	- Derate Above 25°C		0.24	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C
Drain current limited	d by maximum junction temperature.				

Thermal Characteristics

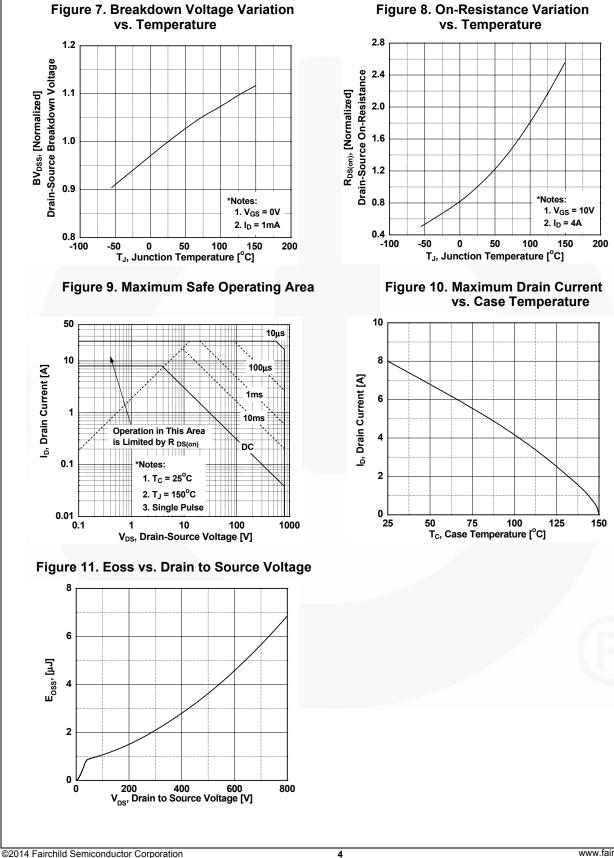
Symbol	Parameter	FCPF650N80Z	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	4.1	0CAA	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

Part Nu	Part Number Top Mark Pa		Pack	age	Packing Method	Reel Si	ze	Tape Widt	h Q	uantity
FCPF650N80Z FCPF650N80Z TO		TO-2	20F	Tube	N/A		N/A	5	50 units	
Electrica	l Char	acteristics T _C = 25 ^c	^o C unle	ss oth	erwise noted.					
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit
Off Charad	teristic	s								
BV _{DSS}			ne '	V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C			800	_	-	V
ΔBV_{DSS}		Drain to Source Breakdown Voltage Breakdown Voltage Temperature				000				
$/\Delta T_{J}$	Coeffic	U 1		I _D = 1	mA, Referenced to 2	5ºC	-	0.8	-	V/ºC
	Zara C	ata Valtaga Drain Currant	'	V _{DS} =	800 V, V _{GS} = 0 V		-	-	25	
DSS	Zero G	ate Voltage Drain Current		$V_{DS} = 640 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{T}_{C} = 125^{\circ}\text{C}$			-	-	250	μA
I _{GSS}	Gate to	Body Leakage Current		$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-	-	±10	μA
On Charac	teristic	s								
V _{GS(th)}	Gate T	nreshold Voltage		V _{GS} =	V _{DS} , I _D = 0.8 mA		2.5	-	4.5	V
R _{DS(on)}		Prain to Source On Resista			10 V, I _D = 4 A		-	530	650	mΩ
9 _{FS}	Forwar	d Transconductance			20 V, I _D = 4 A		-	7.8	-	S
Dynamic (Charact	eristics		-						
C _{iss}	Input C	apacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz			1178	1565	pF	
C _{oss}	Output	Capacitance				1	36	48	pF	
C _{rss}	Revers	e Transfer Capacitance	1			-		0.84	-	pF
C _{oss}		Capacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz		-	18	-	pF	
C _{oss (eff.)}	Effectiv	e Output Capacitance		$V_{\rm DS} = 0 \text{ V to 480 V}, V_{\rm GS} = 0 \text{ V}$			-	124	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 8 \text{ A},$ $V_{GS} = 10 \text{ V}$		-	27	35	nC	
Q _{gs}	Gate to	Source Gate Charge				-	6	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge		00		(Note 4)	-	11	-	nC
ESR	Equival	ent Series Resistance	1	f = 1 MHz		-	1.9	-	Ω	
Switching	Charac	teristics				I			I	
t _{d(on)}	-	n Delay Time					-	17	44	ns
t _r		n Rise Time	,	V _{DD} =	400 V, I _D = 8 A,	-	-	11	32	ns
t _{d(off)}		f Delay Time			10 V, $R_g = 4.7 \Omega$		-	40	90	ns
t _f		f Fall Time			·	(Note 4)	-	3.4	17	ns
		de Characteristics				(1000-1)	/			
I _S		m Continuous Drain to So	urce Di	ode Fo	orward Current		-	_	8	А
I _{SM}		m Pulsed Drain to Source				-	_	24	A	
V _{SD}		Source Diode Forward Vo		$V_{GS} = 0 V, I_{SD} = 8 A$			-	-	1.2	V
t _{rr}		Recovery Time	-		0 V, I _{SD} = 8 A,		-	365	-	ns
Q _{rr}		e Recovery Charge		$v_{GS} = 0.0, v_{SD} = 0.0, A,$ $dI_{F}/dt = 100 A/\mu s$		-	5.9	-	μC	
lotes:		, , , , , , , , , , , , , , , , , , , ,								1 1.0
. Repetitive rating	g: pulse width	limited by maximum junction temp	erature.							
. I _{AS} = 1.6 A, R _G	= 25 Ω, Starti	ng T _J = 25°C								

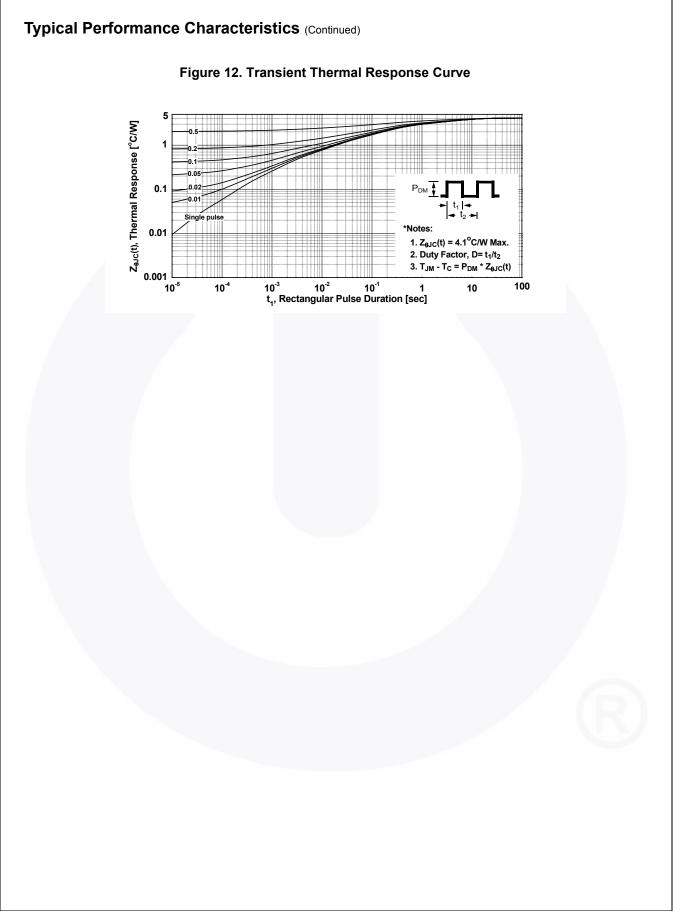


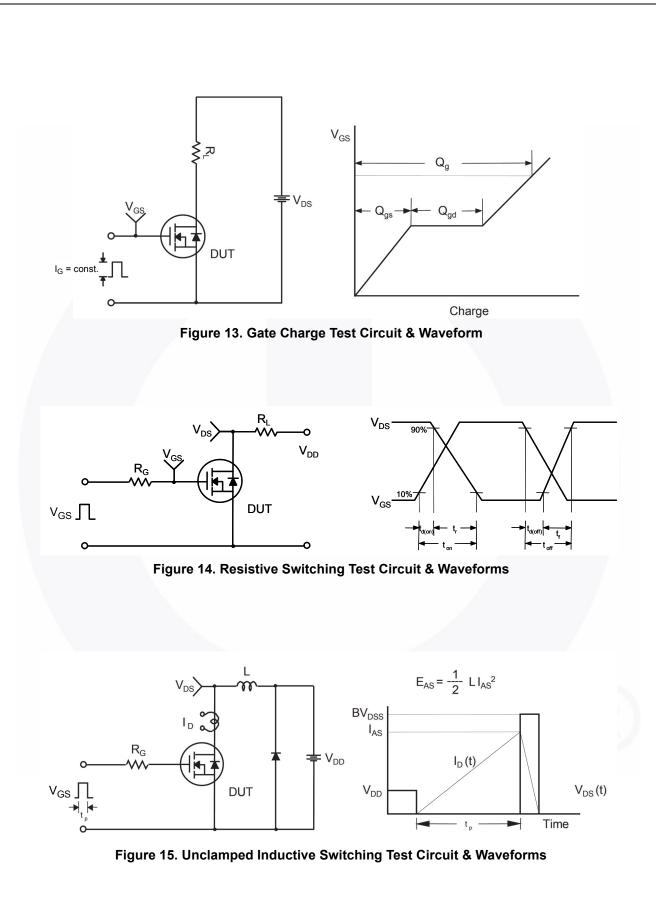
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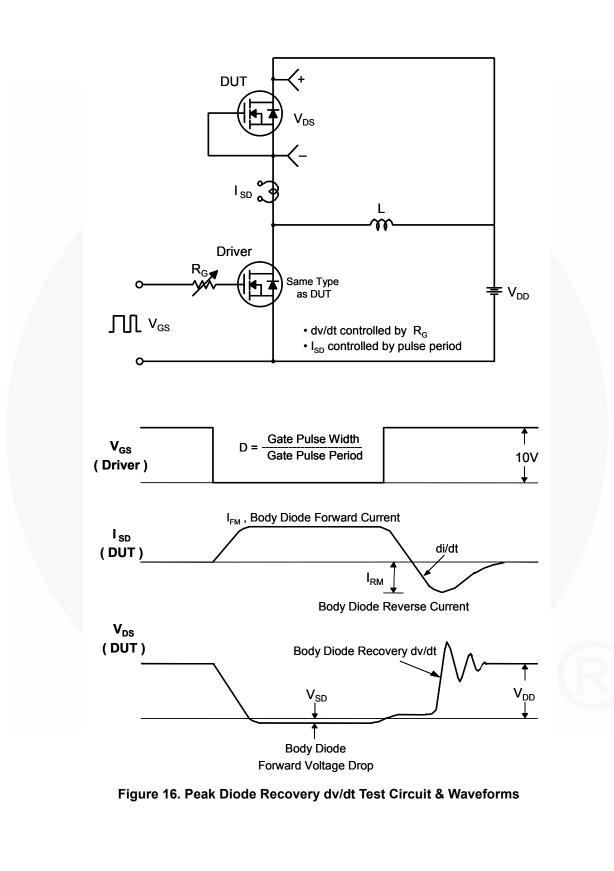
Typical Performance Characteristics (Continued)

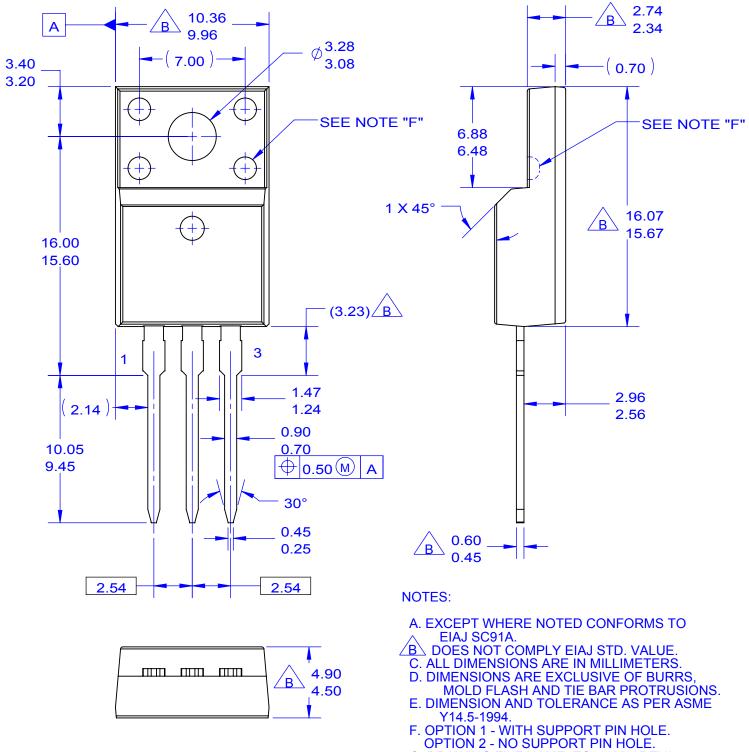




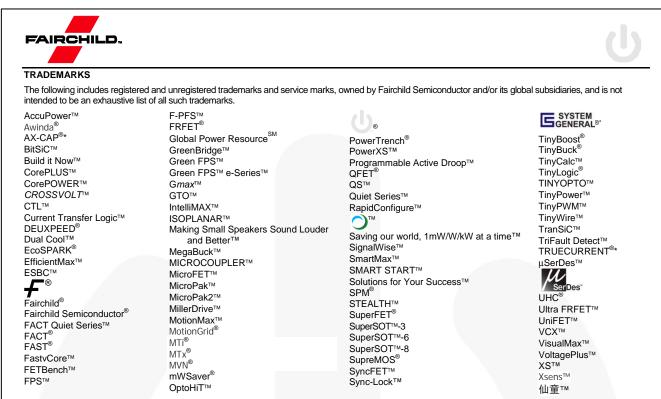
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